

**Specifications** 

Insulation Resistance



SMD Comm X8G HT150C Flex, Ceramic, 0.082 uF, 20%, 50 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 2220, 3.5 mm



| General Information      |  |
|--------------------------|--|
| Series                   | SMD Comm X8G HT150C Flex                     |
| Style                    | SMD Chip                                     |
| Description              | SMD, MLCC, High Temperature,<br>Ultra-Stable |
| Features                 | High Temperature, Ultra-Stable               |
| RoHS                     | Yes  |
| Termination              | Flexible Termination                         |
| Marking                  | No   |
| AEC-Q200                 | No   |
| Typical Component Weight | 130 mg                                       |
| Shelf Life               | 78 Weeks                                     |
| MSL                      | 1  |

| Dimensions |                 |
|------------|-----------------|
| Chip Size  | 2220            |
| L          | 5.9mm +/-0.75mm |
| W          | 5mm +/-0.4mm    |
| Т          | 1mm +/-0.15mm   |
| S          | 3.5mm MIN       |
| В          | 0.7mm +/-0.35mm |
|            |                 |

| 0.082 uF   |
|--|
| 0.002 0.   |
| 1 kHz 1.0Vrms                                      |
| 20%  |
| 50 VDC   |
| 125 VDC  |
| -55/+150°C   |
| X8G  |
| 30 ppm/C, 1kHz 1.0Vrms                             |
| 0.1% 1 kHz 1.0Vrms                                 |
| 0% Loss/Decade Hour: Referee<br>Time is 1000 Hours |
|  |

12.1951 GOhms

| Packaging Specifications |                          |
|--------------------------|--------------------------|
| Packaging                | T&R, 330mm, Plastic Tape |
| Packaging Quantity       | 4000                     |

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